To our customers,

## Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Not recommend for new design

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

Send any inquiries to http://www.renesas.com/inquiry.

# Notice

1. All information included in this document is current as of the date this document is issued. Such information, however, is subject to change without any prior notice. Before purchasing or using any Renesas Electronics products listed herein, please confirm the latest product information with a Renesas Electronics sales office. Also, please pay regular and careful attention to additional and different information to be disclosed by Renesas Electronics such as that disclosed through our website.
2. Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
3. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part.
4. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
5. When exporting the products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations. You should not use Renesas Electronics products or the technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations.
6. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
7. Renesas Electronics products are classified according to the following three quality grades: "Standard", "High Quality", and "Specific". The recommended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below. You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application categorized as "Specific" without the prior written consent of Renesas Electronics. Further, you may not use any Renesas Electronics product for any application for which it is not intended without the prior written consent of Renesas Electronics. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for an application categorized as "Specific" or for which the product is not intended where you have failed to obtain the prior written consent of Renesas Electronics. The quality grade of each Renesas Electronics product is "Standard" unless otherwise expressly specified in a Renesas Electronics data sheets or data books, etc.

   "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots.

   "High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; safety equipment; and medical equipment not specifically designed for life support.

   "Specific": Aircraft; aerospace equipment; submersible repeaters; nuclear reactor control systems; medical equipment or systems for life support (e.g. artificial life support devices or systems), surgical implantations, or healthcare intervention (e.g. excision, etc.), and any other applications or purposes that pose a direct threat to human life.
8. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
9. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or system manufactured by you.
10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
11. This document may not be reproduced or duplicated, in any form, in whole or in part, without prior written consent of Renesas Electronics.
12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries.

(Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries.

(Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

Not recommend for new design

# 3SK318

## Silicon N-Channel Dual Gate MOS FET
## UHF RF Amplifier

REJ03G0819-0200
(Previous ADE-208-600)
Rev.2.00
Aug.10.2005

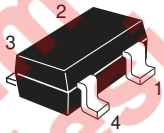
### Features

- Low noise characteristics;
  (NF= 1.4 dB typ. at f= 900 MHz)
- Excellent cross modulation characteristics
- Capable low voltage operation; +B= 5V

Not recommend for new design

### Outline

RENESAS Package code: PTSP0004ZA-A
(Package name: CMPAK-4)




1. Source
2. Gate1
3. Gate2
4. Drain

Note: Marking is “YB–“.

## Absolute Maximum Ratings

(Ta = 25°C)

| Item | Symbol | Ratings | Unit |
|---|---|---|---|
| Drain to source voltage | $V_{DS}$ | 6 | V |
| Gate1 to source voltage | $V_{G1S}$ | ±6 | V |
| Gate2 to source voltage | $V_{G2S}$ | ±6 | V |
| Drain current | $I_D$ | 20 | mA |
| Channel power dissipation | Pch | 100 | mW |
| Channel temperature | Tch | 150 | °C |
| Storage temperature | Tstg | –55 to +150 | °C |

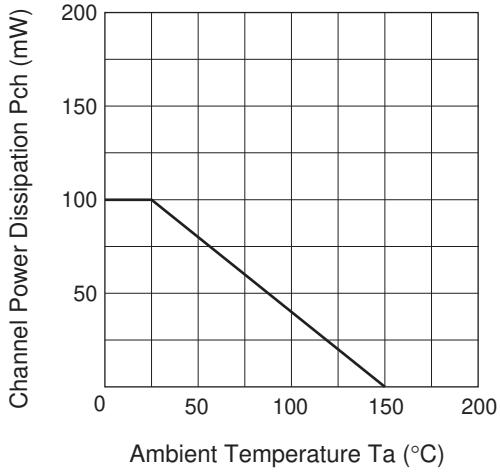
## Electrical Characteristics

(Ta = 25°C)

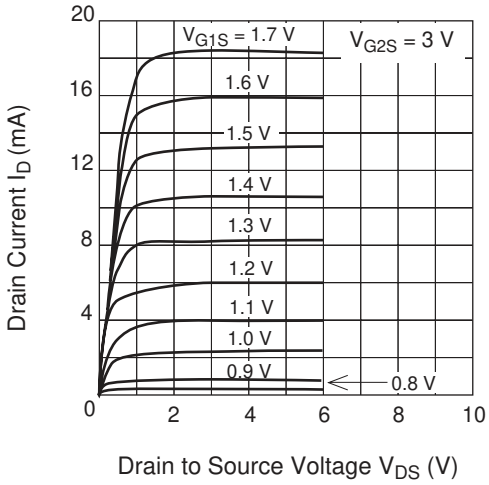
| Item | Symbol | Min | Typ | Max | Unit | Test conditions |
|---|---|---|---|---|---|---|
| Drain to source breakdown voltage | $V_{(BR)DSS}$ | 6 | — | — | V | $I_D$ = 200 µA, $V_{G1S}$ = $V_{G2S}$ = 0 |
| Gate1 to source breakdown voltage | $V_{(BR)G1SS}$ | ±6 | — | — | V | $I_{G1}$ = ±10 µA, $V_{G2S}$ = $V_{DS}$ = 0 |
| Gate2 to source breakdown voltage | $V_{(BR)G2SS}$ | ±6 | — | — | V | $I_{G2}$ = ±10 µA, $V_{G1S}$ = $V_{DS}$ = 0 |
| Gate1 to source cutoff current | $I_{G1SS}$ | — | — | ±100 | nA | $V_{G1S}$ = ±5 V, $V_{G2S}$ = $V_{DS}$ = 0 |
| Gate2 to source cutoff current | $I_{G2SS}$ | — | — | ±100 | nA | $V_{G2S}$ = ±5 V, $V_{G1S}$ = $V_{DS}$ = 0 |
| Gate1 to source cutoff voltage | $V_{G1S(off)}$ | 0.5 | 0.7 | 1.0 | V | $V_{DS}$ = 5 V, $V_{G2S}$ = 3 V<br>$I_D$ = 100µA |
| Gate2 to source cutoff voltage | $V_{G2S(off)}$ | 0.5 | 0.7 | 1.0 | V | $V_{DS}$ = 5 V, $V_{G1S}$ = 3 V<br>$I_D$ = 100 µA |
| Drain current | $I_{DS(op)}$ | 0.5 | 4 | 10 | mA | $V_{DS}$ = 3.5 V, $V_{G1S}$ = 1.1 V<br>$V_{G2S}$ = 3 V |
| Forward transfer admittance | $\|y_{fs}\|$ | 18 | 24 | 32 | mS | $V_{DS}$ = 3.5 V, $V_{G2S}$ = 3 V<br>$I_D$ = 10 mA , f = 1 kHz |
| Input capacitance | $C_{iss}$ | 1.3 | 1.6 | 1.9 | pF | $V_{DS}$ = 3.5 V, $V_{G2S}$ = 3 V<br>$I_D$ = 10 mA , f= 1 MHz |
| Output capacitance | $C_{oss}$ | 0.9 | 1.2 | 1.5 | pF | |
| Reverse transfer capacitance | $C_{rss}$ | — | 0.019 | 0.03 | pF | |
| Power gain | PG | 18 | 21 | — | dB | $V_{DS}$ = 3.5 V, $V_{G2S}$ = 3 V<br>$I_D$ = 10 mA , f = 900 MHz |
| Noise figure | NF | — | 1.4 | 2.2 | dB | |

Not recommend for new design

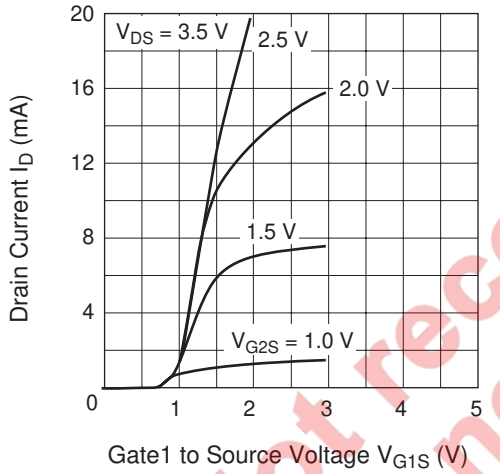
Maximum Channel Power Dissipation Curve



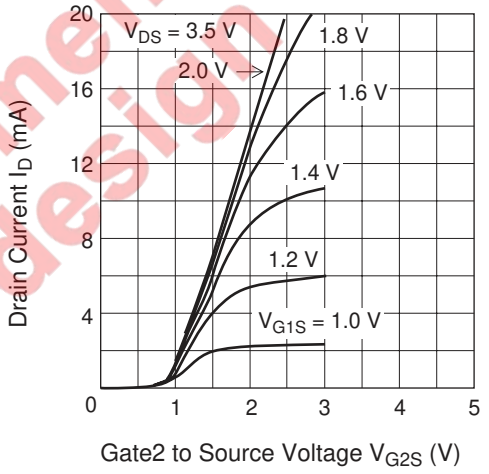

Typical Output Characteristics



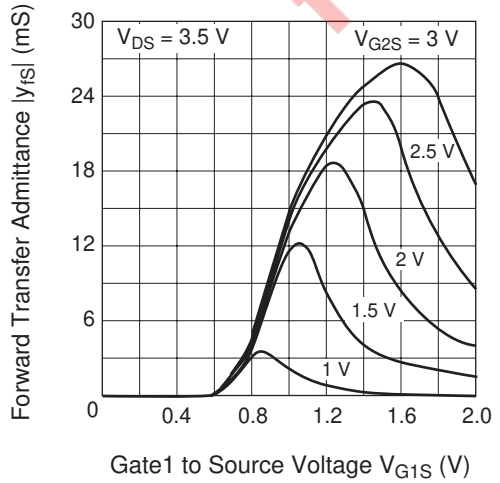

Drain Current vs. Gate1 to Source Voltage



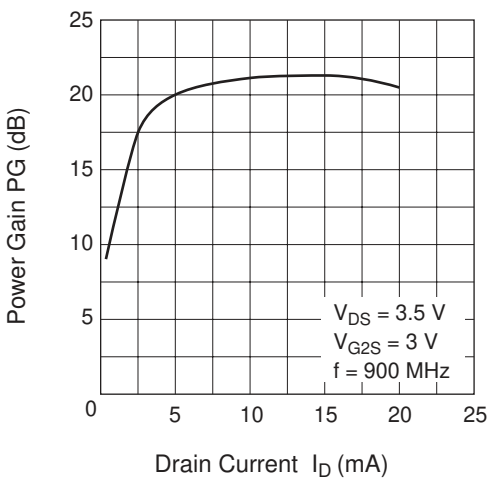

Drain Current vs. Gate2 to Source Voltage




Forward Transfer Admittance vs. Gate1 Voltage

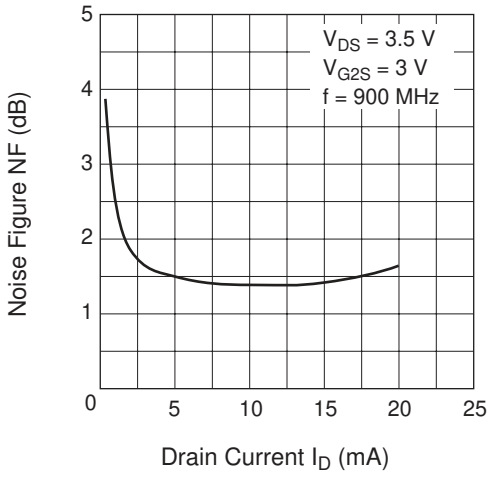



Power Gain vs. Drain Current

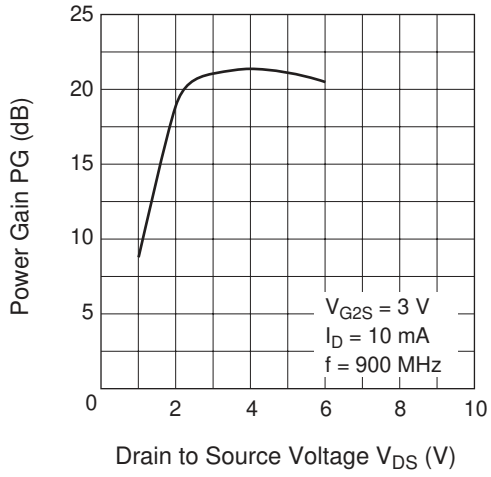



Not recommend for new design

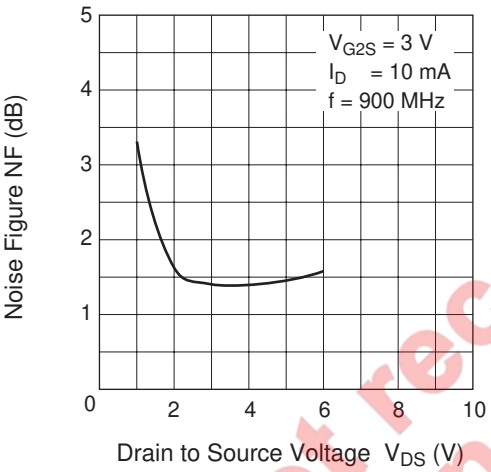
Noise Figure vs. Drain Current



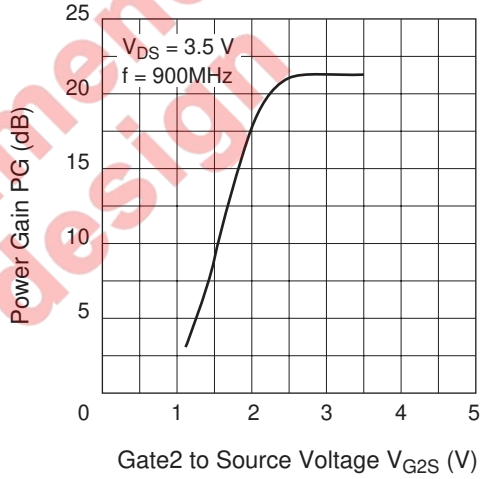

Power Gain vs. Drain to Source Voltage



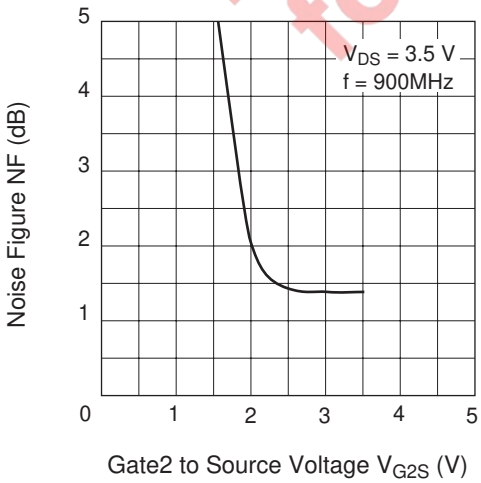

Noise Figure vs. Drain to Source Voltage




Power Gain vs. Gate2 to Source Voltage

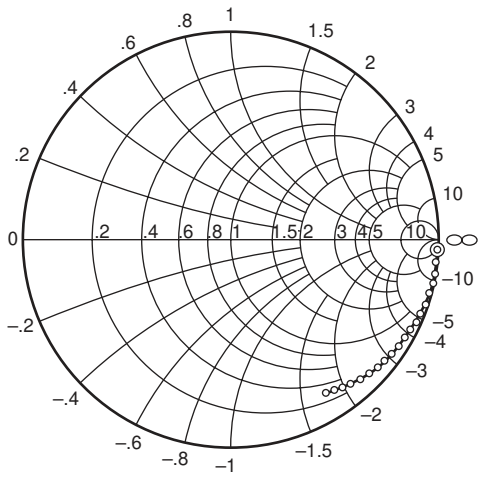



Noise Figure vs. Gate2 to Source Voltage



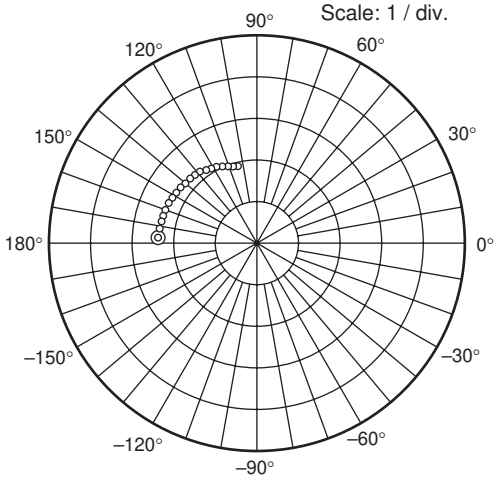

Not recommend for new design

S11 Parameter vs. Frequency



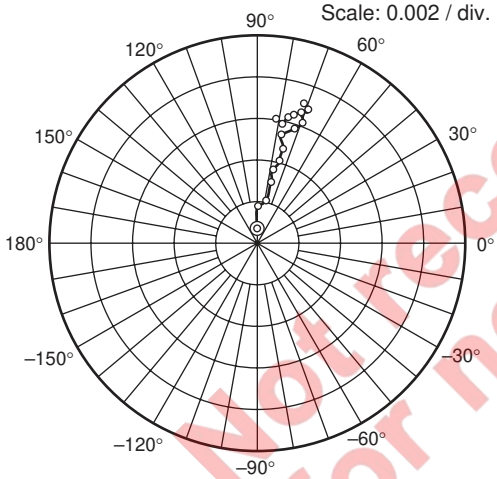

Test Condition : $V_{DS}$ = 3.5 V , $V_{G2S}$ = 3 V
$I_D$ = 10mA
50 to 1000 MHz (50 MHz step)

S21 Parameter vs. Frequency



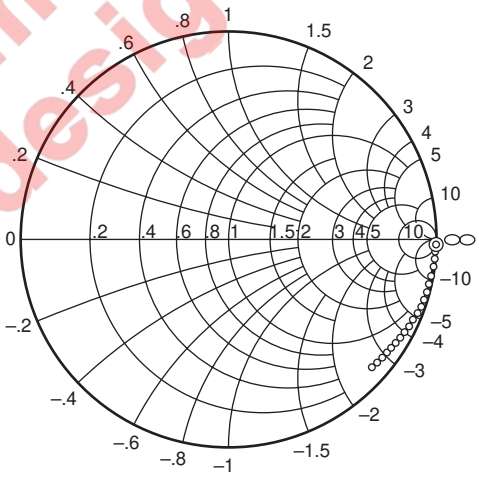

Test Condition : $V_{DS}$ = 3.5 V , $V_{G2S}$ = 3 V
$I_D$ = 10mA
50 to 1000 MHz (50 MHz step)

S12 Parameter vs. Frequency




Test Condition : $V_{DS}$ = 3.5 V , $V_{G2S}$ = 3 V
$I_D$ = 10mA
50 to 1000 MHz (50 MHz step)

S22 Parameter vs. Frequency




Test Condition : $V_{DS}$ = 3.5 V , $V_{G2S}$ = 3 V
$I_D$ = 10mA
50 to 1000 MHz (50 MHz step)

Not recommend for new design

## S Parameter

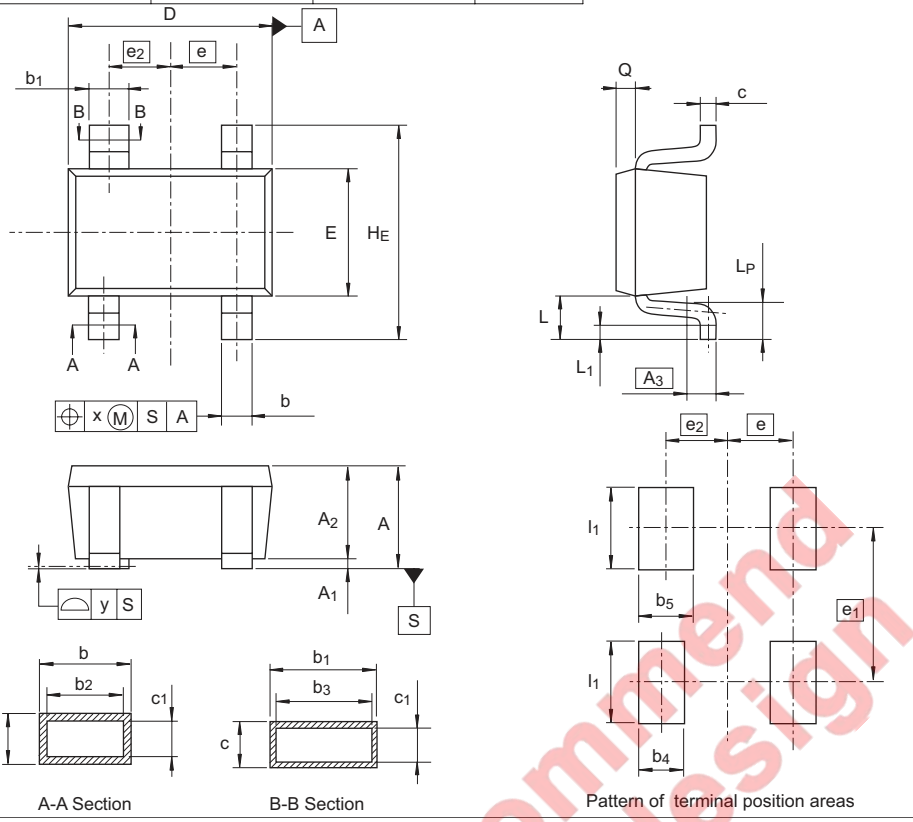
($V_{DS}$ = 3.5V, $V_{G2S}$ = 3V, $I_D$ = 10mA, Zo = 50Ω)

| Freq. (MHz) | S11 | | S21 | | S12 | | S22 | |
|---|---|---|---|---|---|---|---|---|
| | MAG. | ANG. | MAG. | ANG. | MAG. | ANG. | MAG. | ANG. |
| 50 | 1.000 | –2.8 | 2.41 | 176.3 | 0.00068 | 89.1 | 0.999 | –2.2 |
| 100 | 0.998 | –5.8 | 2.41 | 171.9 | 0.00176 | 88.5 | 0.996 | –4.5 |
| 150 | 0.997 | –9.1 | 2.39 | 167.6 | 0.00223 | 80.7 | 0.996 | –6.7 |
| 200 | 0.994 | –12.2 | 2.38 | 163.7 | 0.00303 | 76.6 | 0.994 | –8.7 |
| 250 | 0.994 | –15.1 | 2.37 | 159.8 | 0.00365 | 79.1 | 0.991 | –11.0 |
| 300 | 0.986 | –18.5 | 2.35 | 155.5 | 0.00414 | 75.4 | 0.988 | –13.2 |
| 350 | 0.978 | –21.3 | 2.30 | 151.4 | 0.00484 | 75.0 | 0.983 | –15.3 |
| 400 | 0.972 | –24.1 | 2.28 | 147.6 | 0.00533 | 78.0 | 0.980 | –17.4 |
| 450 | 0.969 | –27.0 | 2.26 | 143.6 | 0.00588 | 71.6 | 0.976 | –19.6 |
| 500 | 0.954 | –29.7 | 2.23 | 140.0 | 0.00617 | 69.5 | 0.971 | –21.7 |
| 550 | 0.955 | –32.8 | 2.19 | 135.9 | 0.00666 | 71.5 | 0.966 | –23.7 |
| 600 | 0.941 | –35.7 | 2.17 | 132.2 | 0.00672 | 70.6 | 0.960 | –25.6 |
| 650 | 0.932 | –38.3 | 2.14 | 128.6 | 0.00694 | 69.0 | 0.955 | –27.8 |
| 700 | 0.924 | –41.3 | 2.09 | 125.0 | 0.00709 | 71.4 | 0.948 | –29.9 |
| 750 | 0.919 | –44.1 | 2.07 | 121.5 | 0.00689 | 69.0 | 0.942 | –31.8 |
| 800 | 0.905 | –46.9 | 2.03 | 117.9 | 0.00699 | 68.9 | 0.937 | –33.8 |
| 850 | 0.896 | –49.2 | 2.00 | 114.7 | 0.00644 | 74.2 | 0.930 | –35.8 |
| 900 | 0.884 | –52.4 | 1.96 | 110.4 | 0.00633 | 75.5 | 0.923 | –37.6 |
| 950 | 0.880 | –54.7 | 1.93 | 107.1 | 0.00585 | 77.8 | 0.917 | –39.8 |
| 1000 | 0.866 | –57.7 | 1.89 | 103.8 | 0.00605 | 82.1 | 0.910 | –41.9 |

Not recommend for new design

## Package Dimensions

| JEITA Package Code | RENESAS Code | Package Name | MASS[Typ.] |
|---|---|---|---|
| SC-82A | PTSP0004ZA-A | CMPAK-4(T) / CMPAK-4(T)V | 0.006g |




| Reference Symbol | Dimension in Millimeters | | |
|---|---|---|---|
| | Min | Nom | Max |
| A | 0.8 | — | 1.1 |
| $A_1$ | 0 | — | 0.1 |
| $A_2$ | 0.8 | 0.9 | 1.0 |
| $\boxed{A_3}$ | — | 0.25 | — |
| b | 0.25 | 0.32 | 0.4 |
| $b_1$ | 0.35 | 0.42 | 0.5 |
| $b_2$ | — | 0.3 | — |
| $b_3$ | — | 0.4 | — |
| c | 0.1 | 0.13 | 0.15 |
| $c_1$ | — | 0.11 | — |
| D | 1.8 | 2.0 | 2.2 |
| E | 1.15 | 1.25 | 1.35 |
| $\boxed{e}$ | — | 0.65 | — |
| $\boxed{e_2}$ | — | 0.6 | — |
| $H_E$ | 1.8 | 2.1 | 2.4 |
| L | 0.3 | — | 0.7 |
| $L_1$ | 0.1 | — | 0.5 |
| $L_P$ | 0.2 | — | 0.6 |
| x | — | — | 0.05 |
| y | — | — | 0.05 |
| $b_4$ | — | — | 0.45 |
| $b_5$ | — | — | 0.55 |
| $\boxed{e_1}$ | — | 1.5 | — |
| $l_1$ | — | — | 0.9 |
| Q | — | 0.2 | — |

Not recommend for new design

## Ordering Information

| Part Name | Quantity | Shipping Container |
|---|---|---|
| 3SK318YB-TL-E | 3000 | ϕ 178 mm Reel, 8 mm Emboss Taping |

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

Renesas Technology Corp. Sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

Keep safety first in your circuit designs!
1. Renesas Technology Corp. puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage.
Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials
1. These materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corp. product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corp. or a third party.
2. Renesas Technology Corp. assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
3. All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Renesas Technology Corp. without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor for the latest product information before purchasing a product listed herein.
The information described here may contain technical inaccuracies or typographical errors.
Renesas Technology Corp. assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.
Please also pay attention to information published by Renesas Technology Corp. by various means, including the Renesas Technology Corp. Semiconductor home page (http://www.renesas.com).
4. When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Renesas Technology Corp. assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.
5. Renesas Technology Corp. semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
6. The prior written approval of Renesas Technology Corp. is necessary to reprint or reproduce in whole or in part these materials.
7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.
Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.
8. Please contact Renesas Technology Corp. for further details on these materials or the products contained therein.

Not recommend for new design

## RENESAS SALES OFFICES

http://www.renesas.com

Refer to "**http://www.renesas.com/en/network**" for the latest and detailed information.

**Renesas Technology America, Inc.**
450 Holger Way, San Jose, CA 95134-1368, U.S.A
Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

**Renesas Technology Europe Limited**
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

**Renesas Technology Hong Kong Ltd.**
7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong
Tel: <852> 2265-6688, Fax: <852> 2730-6071

**Renesas Technology Taiwan Co., Ltd.**
10th Floor, No.99, Fushing North Road, Taipei, Taiwan
Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

**Renesas Technology (Shanghai) Co., Ltd.**
Unit2607 Ruijing Building, No.205 Maoming Road (S), Shanghai 200020, China
Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

**Renesas Technology Singapore Pte. Ltd.**
1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632
Tel: <65> 6213-0200, Fax: <65> 6278-8001

**Renesas Technology Korea Co., Ltd.**
Kukje Center Bldg. 18th Fl., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea
Tel: <82> 2-796-3115, Fax: <82> 2-796-2145

**Renesas Technology Malaysia Sdn. Bhd.**
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia
Tel: <603> 7955-9390, Fax: <603> 7955-9510

© 2005. Renesas Technology Corp., All rights reserved. Printed in Japan.

Colophon .3.0